

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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PX Type

3.2 x 2.5 mm SMD Crystal Oscillator

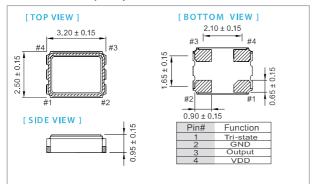
FEATURE

- Typical 3.2 x 2.5 x 0.95mm ceramic SMD package.
- Tight symmetry (45 to 55%) available.
- Operation voltage: 1.8V, 2.5V, 3.3V
- Tri-state enable/disable

TYPICAL APPLICATION

- Computer Peripherals
- Set-top Box , HDTV
- DSC, PDA

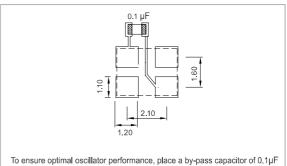
DIMENSION (mm)





RoHS Compliant

SOLDER PAD LAYOUT (mm)



To ensure optimal oscillator performance, place a by-pass capacitor of 0.1μ as close to the part as possible between Vdd and GND pads.

ELECTRICAL SPECIFICATION

Parameter	3.3 V		2.5 V		1.8 V		unit
	Min.	Max.	Min.	Max.	Min.	Max.	uriit
Supply Voltage Variation (VDD)	VDD-10%	VDD+10%	VDD-10%	VDD+10%	VDD-10%	V DD+10%	V
Frequency Range	2.048	200	2.048	166	2.048	110	MHz
V _{DD} Sensitivity (±10 %)	-2	2	-2	2	-2	2	ppm
Supply Current 2.048 MHz ≤ Fo < 30 MHz	_	10	_	8	_	6	
30 MHz≦ Fo< 75 MHz	_	15	_	10	_	8	
75 MHz≦ Fo <133 MHz	_	20	_	15	_	12	mA
133 MHz≦ Fo <166 MHz	_	22	_	15	_	_	
166 MHz≦ Fo≦200 MHz	_	25	_	_	_	_	
Duty Cycle	45	55	45	55	45	55	%
Output Level (CMOS)							
Output High (Logic "1")	2.97	_	2.25	_	1.62	_	V
Output Low (Logic "0")	_	0.33	_	0.25	_	0.18	
Transition Time:Rise/Fall Time+							
2.048 MHz ≦ Fo < 10 MHz	_	3	_	4	_	5	-0
10 MHz ≦ Fo	_	2	_	3	_	4	nSec
Start Time	_	2	_	2	_	2	mSec
Tri-State(Input to Pin 1)							
Enable (High voltage or floating)	2.31	_	1.75	_	1.26	_	V
Disable (Low voltage or GND)	_	0.99	_	0.75	_	0.54	
Period Jitter(Pk-Pk)							
Specific Frequency"	_	40	_	40	_	40	pSec
Others	_	200	_	200	_	200	psec
Standby Current	_	15	_	15	_	15	μΑ
Aging (@ 25°C 1st year)	_	±3	_	±3	_	±3	ppm
Storage Temp. Range	-55	125	-55	125	-55	125	°C

Standard frequencies are frequencies which the crystal has been designed and does not imply a stock position.

FREQ. STABILITY vs. TEMP. RANGE

Temp. (°C)	±20	±25	±50
-10 ~ +60	0	0	0
-20 ~ +70	\triangle	0	0
-40 ~ +85	×	0	0

^{* ○:} Available △:Conditional X: Not available

⁺ Transition times are measured between 10% and 90% of VDD, with an output load of 15pF.

[&]quot;Specific frequency including 4.0, 6.0, 8.0, 12.0, 13.0, 16.0, 19.2, 20.0, 24.0, 26.0, 32.0, 38.4 and 40.0MHz

 $^{^{\}star}$ Inclusive of calibration @ 25 °C, operating temperature range, input voltage variation, load variation, aging (1st year), shock, and vibration